



Click [here](#) for the 3D model.

### Dimensions

|           |                                       |
|-----------|---------------------------------------|
| Chip Size | 1210                                  |
| L         | 3.2mm +/-0.25mm (0.126 in +/-0.01 in) |
| W         | 2.5mm +/-0.25mm (0.098 in +/-0.01 in) |
| T         | 1.5mm (0.059 in)                      |
| B         | 0.5mm +/-0.25mm (0.02 in +/-0.01 in)  |

### Packaging Specifications

|                    |                          |
|--------------------|--------------------------|
| Packaging          | T&R, 178mm, Plastic Tape |
| Packaging Quantity | 2500                     |

### General Information

|                         |  |
|-------------------------|--|
| Series                  | SMD Mil PRF55681   |
| Style                   | SMD Chip   |
| RoHS                    | No   |
| Prop 65                 | <b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> . |
| SCIP Number             | db44bada-287e-465e-9a06-2b93bb6487ea   |
| Termination             | Lead (SnPb)  |
| Failure Rate            | M (1%/1000 Hrs)  |
| Testing and Reliability | MIL-PRF-55681  |
| Qualifications          | MIL-PRF-55681  |
| AEC-Q200                | No   |
| Miscellaneous           | Termination Description: SolderPlate 70-30.  |
| Shelf Life              | 78 Weeks   |
| MSL                     | 1  |

### Specifications

|                         |            |
|-------------------------|------------|
| Capacitance             | 0.056 uF   |
| Capacitance Tolerance   | 10%        |
| Voltage DC              | 50 VDC     |
| Temperature Range       | -55/+125°C |
| Temperature Coefficient | BX         |

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)